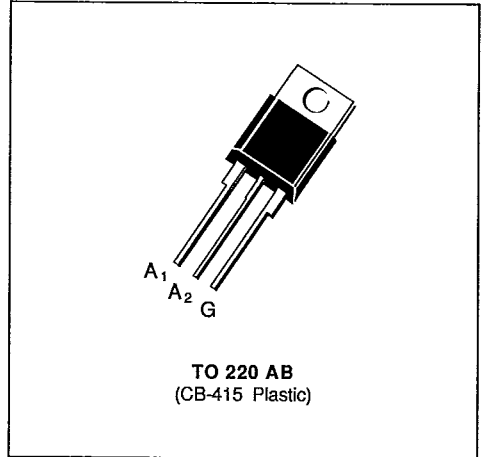


S G S-THOMSON

SNUBBERLESS TRIACS

- $I_{TRMS} = 8 \text{ A}$ at $T_c = 90^\circ \text{C}$.
- $V_{DRM} : 200 \text{ V}$ to 800 V .
- $I_{GT} = 50 \text{ mA}$ (QI-II-III).
- GLASS PASSIVATED CHIP.
- HIGH SURGE CURRENT : $I_{TSM} = 80 \text{ A}$.
- HIGH COMMUTATION CAPABILITY :
(di/dt)_c > 7 A / ms without snubber.
- INSULATING VOLTAGE : 2500 V_{RMS} .



DESCRIPTION

New range suited for applications such as phase control and static switching on inductive or resistive load.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
I_{TRMS}	RMS on-state current (360° conduction angle)	$T_c = 90^\circ \text{C}$ 8	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$t = 8.3 \text{ ms}$	85
		$t = 10 \text{ ms}$	80
I^2t	I^2t value	$t = 10 \text{ ms}$	A^2s
di/dt	Critical rate of rise of on-state current (1)	Repetitive $F = 50 \text{ Hz}$	20
		Non Repetitive	100
T_{stg} T_j	Storage and operating junction temperature range	- 40, + 150 - 40, + 125	$^\circ \text{C}$ $^\circ \text{C}$

Symbol	Parameter	BTA 08-					Unit
		200 BW	400 BW	600 BW	700 BW	800 BW	
V_{DRM}	Repetitive peak off-state voltage (2)	± 200	± 400	± 600	± 700	± 800	V

(1) Gate supply : $I_G = 500 \text{ mA}$ - $di/dt = 1 \text{ A / } \mu\text{s}$.

(2) $T_j = 125^\circ \text{C}$.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient	60	$^{\circ}\text{C}/\text{W}$
$R_{th(j-c)}$ DC	Junction to case for DC	4.3	$^{\circ}\text{C}/\text{W}$
$R_{th(j-c)}$ AC	Junction to case for 360 $^{\circ}$ conduction angle (F = 50 Hz)	3.2	$^{\circ}\text{C}/\text{W}$

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 40 \text{ W}$ ($t = 10 \mu\text{s}$) $P_{G(AV)} = 1 \text{ W}$ $I_{GM} = 4 \text{ A}$ ($t = 10 \mu\text{s}$) $V_{GM} = 16 \text{ V}$ ($t = 10 \mu\text{s}$).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25 \text{ }^{\circ}\text{C}$ Pulse duration > 20 μs	$V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$	I-II-III	2		50	mA
V_{GT}	$T_j = 25 \text{ }^{\circ}\text{C}$ Pulse duration > 20 μs	$V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$	I-II-III			1.5	V
V_{GD}	$T_j = 125 \text{ }^{\circ}\text{C}$ Pulse duration > 20 μs	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$	I-II-III	0.2			V
I_H^*	$T_j = 25 \text{ }^{\circ}\text{C}$ Gate open	$I_T = 100 \text{ mA}$ $R_L = 140 \text{ } \Omega$				50	mA
I_L	$T_j = 25 \text{ }^{\circ}\text{C}$ Pulse duration > 20 μs	$V_D = 12 \text{ V}$ $I_G = 500 \text{ mA}$	I-III		50		mA
			II		100		
V_{TM}^*	$T_j = 25 \text{ }^{\circ}\text{C}$	$I_{TM} = 11 \text{ A}$ $t_p = 10 \text{ ms}$				1.75	V
I_{DRM}^*	$T_j = 25 \text{ }^{\circ}\text{C}$	V_{DRM} rated Gate open				0.01	mA
	$T_j = 125 \text{ }^{\circ}\text{C}$					2	
dv/dt^*	$T_j = 125 \text{ }^{\circ}\text{C}$ Linear slope up to 0.67 V_{DRM}	Gate open		500	750		V/ μs
$(di/dt)_c^*$	$T_j = 125 \text{ }^{\circ}\text{C}$ Without snubber	V_{DRM} rated		7	14		A/ms
t_{gt}	$T_j = 25 \text{ }^{\circ}\text{C}$ $I_T = 11 \text{ A}$	$di_G/dt = 3.5 \text{ A}/\mu\text{s}$ $V_D = V_{DRM}$	$I_G = 500 \text{ mA}$ I-II-III		2		μs

* For either polarity of electrode A_2 voltage with reference to electrode A_1 .

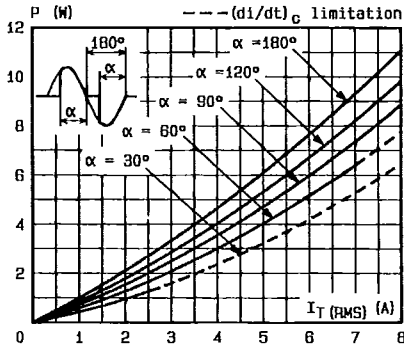


Fig. 1 - Maximum mean power dissipation versus RMS on-state current (F = 60 Hz).

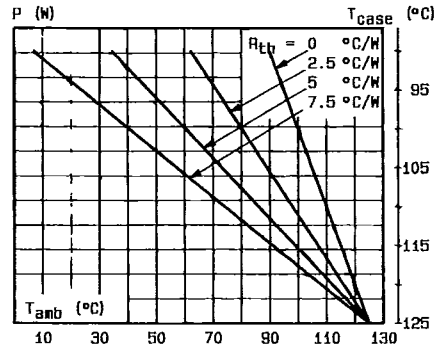


Fig. 2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

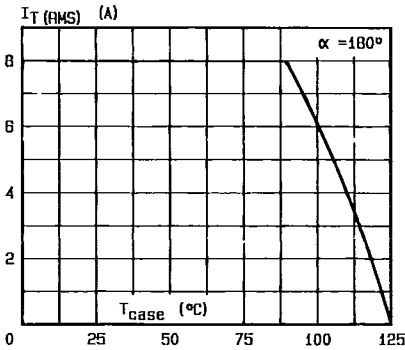


Fig. 3 - RMS on-state current versus case temperature.

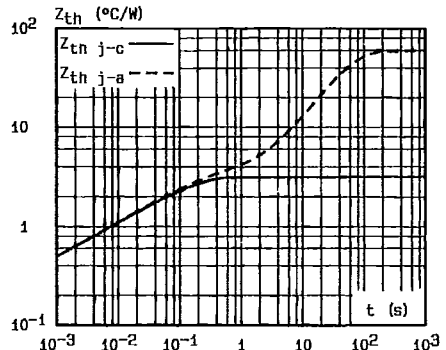


Fig. 4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

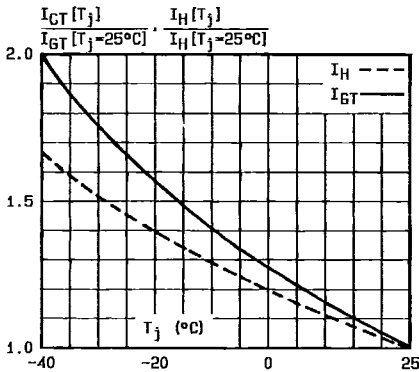


Fig. 5 - Relative variation of gate trigger current and holding current versus junction temperature.

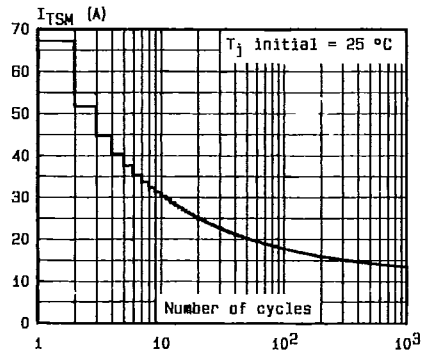


Fig. 6 - Non repetitive surge peak on-state current versus number of cycles.

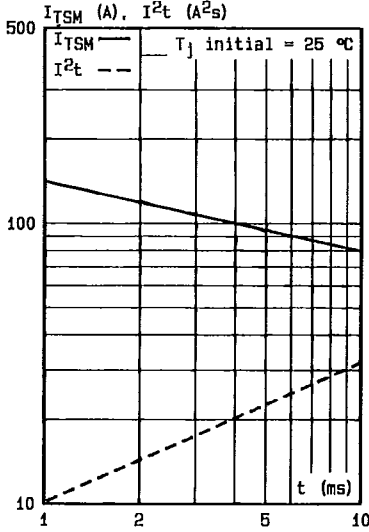


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms. and corresponding value of I^2t .

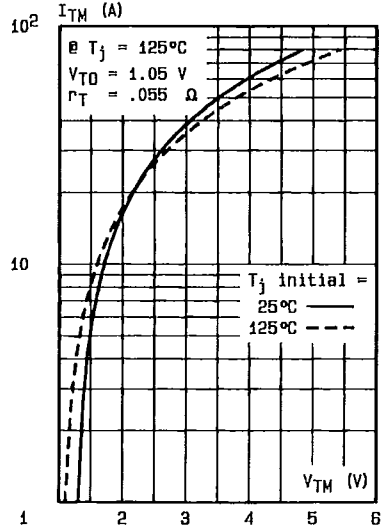
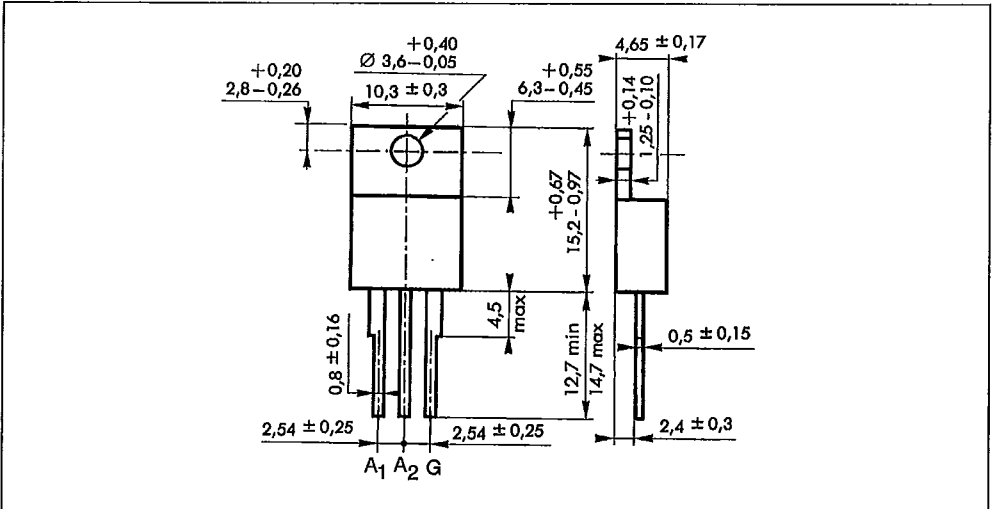


Fig.8 - On-state characteristics (maximum values).

PACKAGE MECHANICAL DATA

TO 220 AB (CB-415) Plastic



Cooling method : by conduction (method C)
 Marking : type number
 Weight : 2 g